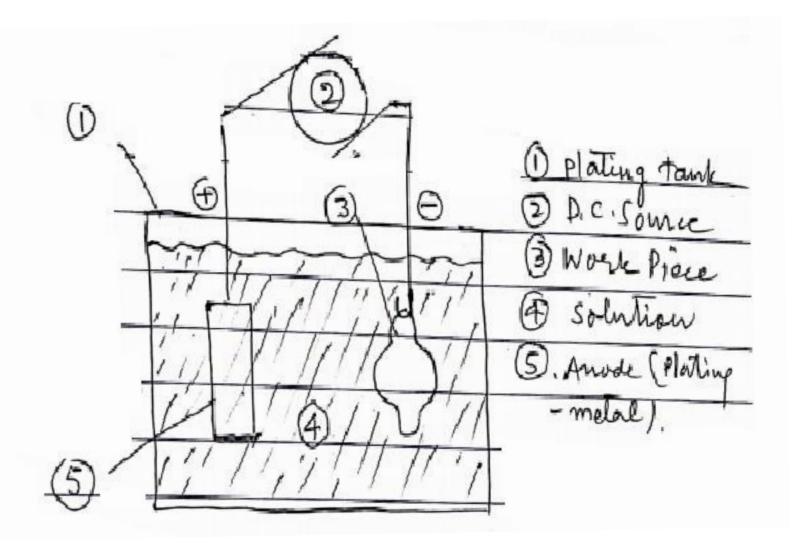
Modern manufacturing processes and management ME-504 Unit 2

Coating and Deposition processes:

Plating and related process, physical vapour deposition, chemical vapour deposition, organic coating

Electro platting. Electroplating Coatings on The surfaces of metals and sometimes on non melals. This is done for protection against Corression or against wear and abvasion for appearance, to re-work worn parts by merene in Size, to make pieces easy to solder and to stop off areas on steel parts from being during heat treatment.



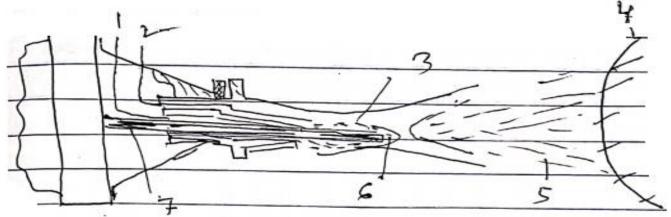
Common plating metals are chrominum nickel per Zine Cadengian Cadmium, and tin. The more precious metals - Silver, gold, and thodeum are also applied by plating. Surface to be plated must is then cleaned in suitable cleaning solution

& remove grease dist buffing Compound etc After rinsing the part is really for platting. The four essential elements of a plating process are The callhode anode electrolyte, and direct current, shey are shown in ty The current leaves the anude which is a ban of plating metal, and migrate through the electrolyte (worter solution of salts of the melal to applied) to the cathode, or part to be plated. As The cons are deposited on the cathode; they give up Their change and are deposited on metal or the carthode Ponto to be plated should be designed with generous fillets and tradic instead of sharp corner, since current Concentrations occur at sharp points L'emlting in excessive deposit

(2) Hot Depping: - (Galvanizing) A proTective coating may be applied on metal pieces by depping them into cestain metals like Zinc tin or alloy of lead and tin. Depping is an economical way of putting on a heavy and enduring Coating. To obtain an even loating on small object such as nuts & both, pins, and washers, the objects are centifuged after being Torken from the molten bath until the coating is hard. Lenc depping or hot galvanizing is widely used on steel as an effective protective larger against corrorion. The parts are first cleaned and fixed is a solution of Zine chloride and Hal

Metal Spraying; Metal spraying is barically intended to Confer Some physical property on a surface. The appearance of foor surfaces on Carting can be improved by metal spraying, sprayed metal can be decorative, like aluminimum or bronze on cast iron some can even be coloured.

Metal spraying is done by melting a metal in an 6xy-gar plane and blowing it from the norse



1; 0xy-frel gas 2, compressed ais, 3; Flame 4. Work Piece, 5 Automized Spray 6, Melting 7. Wine: in The form of wire is feed by powered rollers to the flame, but some gun uses powder or granulates metal. The process uses compressed air to atomize fully The molten metal or oxides and project them against a prepared Surface, where they are embeded, arming good mechanical adhersion. This is illustrated in fre 1. The surface must be roughened first and be free from dirt orl 4 greans. The compressed are helps cool the work pieces, so that the coatings may be applied successfully not only to metals but to glass, wood, askestos and certain planties. Gun may be operated by

Metallization: Metallisation is an interesting application of the opy- accetylene flame. This Technique essentially consists in laying deposits Which Vary both is natine and in Thickness on the Widest Variety of parts. Trinuple: The material to be deposited a Melted in a flame and Subsequently proliverisa and sprayed in fine droplets on the part, to be Coaled. The Equipment used is a gun. It compos ses a special torch, coupled with a compressed our pulverising device and a system of The product,

Any product can be sprayed: metal ceramic plantics on to any metal and under certain conditions on to many non-metallic supports; wood, planter plantics etc, Metallised surfaces laid in a thin layer of from 40 to 200 4 m (Zincan aluminium) provide a much stronger and longer larting protection against Corrosion Than any other more or less composite film.

Deposition
Photoreint Thin layer
Substite

As indicated in tig. a thin layer has a to be deposited on the substrate. There are a number of metallic methods for deposition of a crystalline layer on the substrate. The Common method are equitary, sputtering, oxidation, chemical

Vapour deposition, an odic bonding etc.

Chemical Vapour deposition (CVD) that is typically carried out at temperature greater Than 1000°C. In molecular beam epitonoy (MBE), The process is carried out in ultra high vacuum. And it is boned on

Physical Vapour deposition. Physical vapour deposition (PVD), Sometimes (especially in 5) ngle - crystal growth contests called physi - cal Vapor transport (PVT), describe a valely of Vacuum deposition methods which can be used to produce thin films and Coatings PVD is characterized by a process in Which the material goes from a condensed phase to a Vorpour phase and then back to thin film Condensed phase. The most Common PVD processes are sputtering () and evapora-- him PVD is used in the manufacture of tems which require their films for mechanical optione, chemical or electronic functions. Examples includes, Service conductor dervies much as Thin film solar panels Aluminized PET

outed cutting dump deposition jets waste on The parts are ho

used has; er of mo cutting aluminium

Organice Vapour phase deposition: For the growth of thin film of optically non-tenear organic salts, The components Eleact to form a polycrystalline thin film. on Substrates of glass and gold. Excess rectants and reaction products are purged from the system by the carrier gas the component reacts to form a polyerystalline thin Jilm on substrates

1 glass or gold. Excess reactants and reaction products are purged from the nyslem by the Carrier gas. As an example, we demonstrate The growth of polyerystalline, optically non-linear thin film q 4 - demetly lamino - N - methyl - 4 - 5h'sazolum to sylate (DAST) with 9 95 go pronty